

Hyperfast Rectifier, 30 A FRED Pt® G5



LINKS TO ADDITIONAL RESOURCES





| PRIMARY CHARACTERISTICS | | | | | | | | |
|--|-------------|--|--|--|--|--|--|--|
| I _{F(AV)} | 30 A | | | | | | | |
| V _R | 600 V | | | | | | | |
| V _F at I _F at 125 °C | 1.15 V | | | | | | | |
| t _{rr} (typ.) | 25 ns | | | | | | | |
| T _J max. | 175 °C | | | | | | | |
| Package | TO-220AC 2L | | | | | | | |
| Circuit configuration | Single | | | | | | | |

FEATURES

 Best in class forward voltage drop and switching losses trade off



- Optimized for high speed operation
- 175 °C maximum operating junction temperature
- Polyimide passivation
- Meets JESD 201 class 1A whisker test
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

Featuring a unique combination of low conduction and switching losses, this rectifier is the right choice for soft switched and resonant converters, as well as medium frequency hard switching converters. This device is specifically designed to improve efficiency of high speed LLC output rectification stages of EV / HEV battery charging stations and high frequency stages of UPS applications.

MECHANICAL DATA

Case: TO-220AC 2L

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

| ABSOLUTE MAXIMUM RATINGS | | | | | | | | | | |
|--|-----------------------------------|--|-------------|-------|--|--|--|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | | | | | |
| Repetitive peak reverse voltage | V_{RRM} | | 600 | V | | | | | | |
| Average rectified forward current | I _{F(AV)} | T _C = 113 °C, D = 0.50 | 30 | Α | | | | | | |
| Repetitive peak forward current | I _{FRM} | $T_C = 113 ^{\circ}\text{C}, D = 0.50, f = 20 \text{kHz}$ | 60 | | | | | | | |
| Non-repetitive peak surge current | I _{FSM} | $T_C = 25$ °C, $t_p = 10$ ms, sine wave | 330 | | | | | | | |
| Operating junction and storage temperature | T _J , T _{Stg} | | -55 to +175 | °C | | | | | | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | | | | | |
|--|-----------------|--|------|------|------|-------|--|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | | | |
| Breakdown voltage, blocking voltage | V_{BR}, V_{R} | I _R = 100 μA | 600 | - | - | | | | | |
| Farmend valtage | V | I _F = 30 A | - | 1.3 | 1.6 | V | | | | |
| Forward voltage | V _F | I _F = 30 A, T _J = 125 °C | - | 1.15 | - |] | | | | |
| Dayreya laakawa ayyyant | | $V_R = V_R$ rated | | - | 20 | | | | | |
| Reverse leakage current | I _R | T _J = 125 °C, V _R = V _R rated | - | - | 500 | μA | | | | |
| Junction capacitance | C _T | V _R = 200 V | - | 36 | - | pF | | | | |
| Series inductance | L _S | Measured to lead 5 mm from package body | - | 8 | - | nH | | | | |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | | | | |
|---|------------------|--------------------------|---|------|------|-------|----|--|--|--|
| PARAMETER | SYMBOL | TEST CO | MIN. | TYP. | MAX. | UNITS | | | | |
| | | $I_F = 1.0 A, dI_F/dt =$ | 100 A/μs, V _R = 30 V | 1 | 25 | - | | | | |
| Reverse recovery time | t _{rr} | T _J = 25 °C | | - | 41 | - | ns | | | |
| | | T _J = 125 °C | | - | 58 | - | | | | |
| Peak recovery current | 1 | T _J = 25 °C | $I_F = 20 \text{ A}$ | - | 19 | - | А | | | |
| | I _{RRM} | T _J = 125 °C | dI _F /dt = 1000 A/μs V _B = 400 V | - | 32 | - | | | | |
| Devenue vecevent eberge | Q _{rr} | T _J = 25 °C | | - | 419 | - | nC | | | |
| Reverse recovery charge | | T _J = 125 °C | | - | 1176 | - | | | | |
| Poverse receivery time | | T _J = 25 °C | | - | 46 | - | ns | | | |
| Reverse recovery time | t _{rr} | T _J = 125 °C | | - | 65 | - | | | | |
| Dools recovery ourset | | T _J = 25 °C | I _F = 30 A dI _F /dt = 1000 A/µs | - | 21 | - | А | | | |
| Peak recovery current | I _{RRM} | T _J = 125 °C | $V_{\rm R} = 400 \text{ V}$ | - | 36 | - | | | | |
| D | | T _J = 25 °C | | - | 550 | - | C | | | |
| Reverse recovery charge | Q _{rr} | T _J = 125 °C | 1 | - | 1560 | - | nC | | | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | | | | | |
|--|-----------------------------------|------------------------|--------------|------|------------|------------------------|--|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | | | | |
| Thermal resistance, junction-to-case | R _{thJC} | | - | - | 1.3 | °C/W | | | | |
| Weight | | | - | 2.0 | - | g | | | | |
| Mounting torque | | | 6.0 (5.0) | - | 12 (10) | kgf · cm (lbf · in) | | | | |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | 175 | °C | | | | |
| Marking device | | Case style TO-220AC 2L | E5TH3006 | | | | | | | |

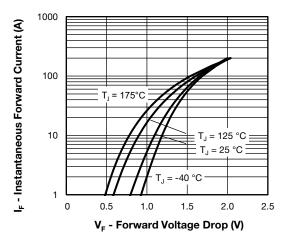


Fig. 1 - Forward Voltage Drop Characteristics, Per Leg

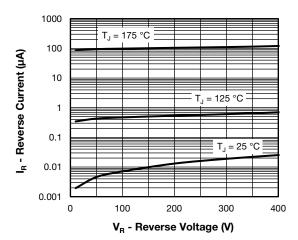


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage, Per Leg

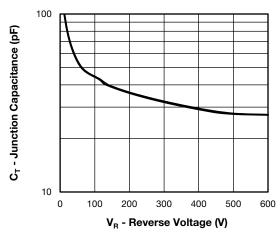


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage, Per Leg

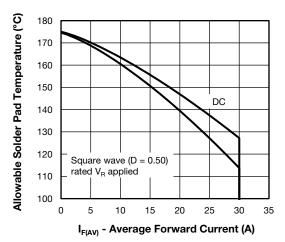


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current, Per Leg

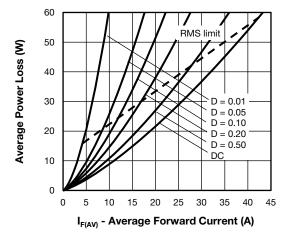


Fig. 5 - Forward Power Loss Characteristics, Per Leg

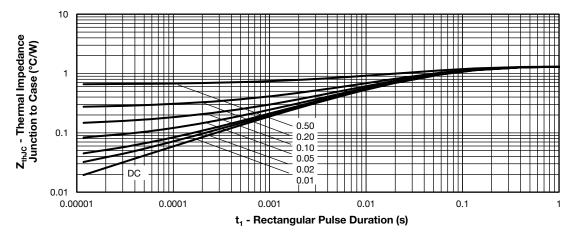


Fig. 6 - Transient Thermal Impedance, Junction to Case, Per Leg



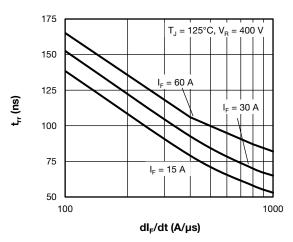


Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt, Per Leg

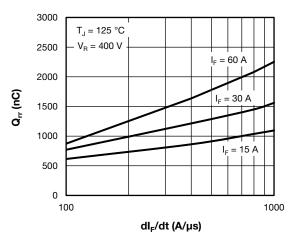


Fig. 8 - Typical Reverse Recovery Charge vs. dl_F/dt, Per Leg

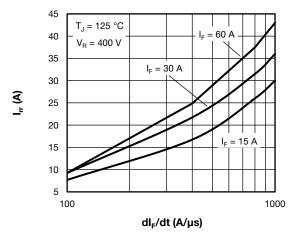


Fig. 9 - Typical Reverse Recovery Current vs. dl_F/dt, Per Leg

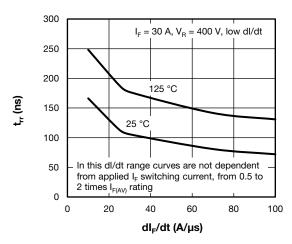


Fig. 10 - Typical Reverse Recovery Time vs. dl_F/dt, Per Leg

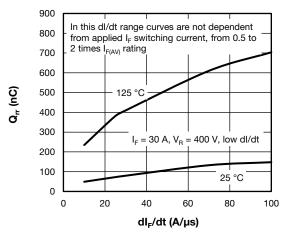


Fig. 11 - Typical Reverse Recovery Charge vs. dI_F/dt, Per Leg

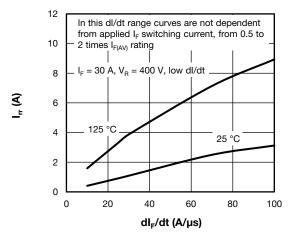


Fig. 12 - Typical Reverse Recovery Current vs. dl_F/dt, Per Leg

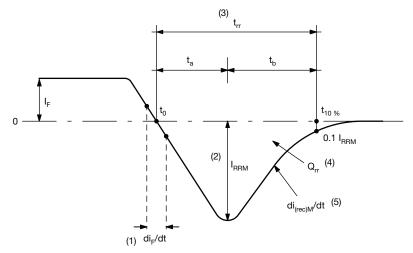


Fig. 13 - Reverse Recovery Waveform and Definitions

Notes

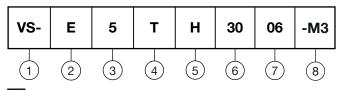
- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from t₀, crossing point of negative going I_F, to point t_{10%}, 0.1 I_{RRM}
- $^{(4)}$ Q_{rr} area under curve defined by t_0 and t_{10} %

$$Q_{rr} = \int_{t_0}^{t_{10}\%} I(t)dt$$

(5) di_(rec)M/dt - peak rate of change of current during t_b portion of t_{rr}

ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

2 - E = single diode

3 - 5 = FRED generation 5

- Package: T = TO-220AC 2L

5 - H = hyperfast recovery

6 - Current rating (30 = 30 A)

7 - Voltage rating (06 = 600 V)

8 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

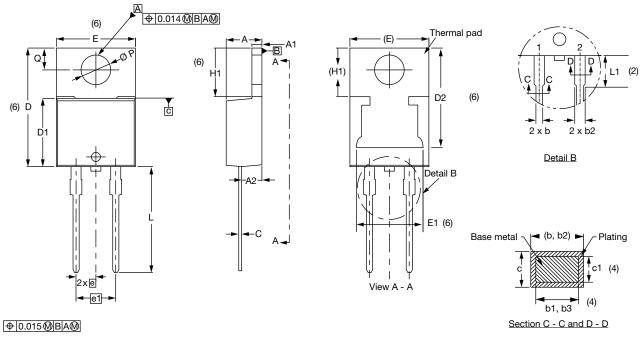
| ORDERING INFORMATION (Example) | | | | | | | | | |
|--------------------------------|---------------|-------------------------|--|--|--|--|--|--|--|
| PREFERRED P/N | BASE QUANTITY | PACKAGING DESCRIPTION | | | | | | | |
| VS-E5TH3006-M3 | 50 | Antistatic plastic tube | | | | | | | |

| LINKS TO RELATED DOCUMENTS | | | | | | | |
|--|--------------------------|--|--|--|--|--|--|
| Dimensions <u>www.vishay.com/doc?96156</u> | | | | | | | |
| Part marking information | www.vishay.com/doc?95391 | | | | | | |
| SPICE model | www.vishay.com/doc?96919 | | | | | | |



TO-220AC 2L

DIMENSIONS in millimeters and inches



Lead tip

Conforms to JEDEC® outline TO-220AC

| SYMBOL | BOL MILLIMETERS INCHES NOTES | | SYMBOL | MILLIMETERS | | INCHES | | NOTES | | | | |
|--------|------------------------------|-------|--------|-------------|-------|--------|----------|-------|-------|-------|-------|-------|
| STMBOL | MIN. | MAX. | MIN. | MAX. | NOTES | NOTES | STIVIBOL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 4.25 | 4.65 | 0.167 | 0.183 | | | D2 | 11.68 | 13.30 | 0.460 | 0.524 | 6, 7 |
| A1 | 1.14 | 1.40 | 0.045 | 0.055 | | | E | 10.11 | 10.51 | 0.398 | 0.414 | 3, 6 |
| A2 | 2.50 | 2.92 | 0.098 | 0.115 | | | E1 | 6.86 | 8.89 | 0.270 | 0.350 | 6 |
| b | 0.69 | 1.01 | 0.027 | 0.040 | | | е | 2.41 | 2.67 | 0.095 | 0.105 | |
| b1 | 0.38 | 0.97 | 0.015 | 0.038 | 4 | | e1 | 4.88 | 5.28 | 0.192 | 0.208 | |
| b2 | 1.20 | 1.73 | 0.047 | 0.068 | | | H1 | 6.09 | 6.48 | 0.240 | 0.255 | 6 |
| b3 | 1.14 | 1.73 | 0.045 | 0.068 | 4 | | L | 13.52 | 14.02 | 0.532 | 0.552 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | | | L1 | 3.32 | 3.82 | 0.131 | 0.150 | 2 |
| c1 | 0.36 | 0.56 | 0.014 | 0.022 | 4 | | ØΡ | 3.54 | 3.91 | 0.139 | 0.154 | |
| D | 14.85 | 15.35 | 0.585 | 0.604 | 3 | | Q | 2.60 | 3.00 | 0.102 | 0.118 | |
| D1 | 8.38 | 9.02 | 0.330 | 0.355 | | | | | | | | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension and finish uncontrolled in L1
- (3) Dimension D, D1, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Dimension b1, b3, and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2, and E1
- (7) Outline conforms to JEDEC® TO-220, except D2



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Vishay

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